

## OptiMOS® -P2 Power-Transistor



### Features

- P-channel - Logic Level - Enhancement mode
- AEC qualified
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- Green Product (RoHS compliant)
- 100% Avalanche tested
- Intended for reverse battery protection

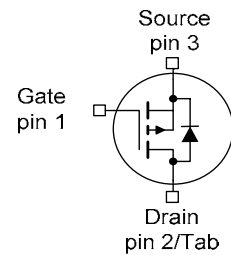
### Product Summary

|                            |      |    |
|----------------------------|------|----|
| $V_{DS}$                   | -30  | V  |
| $R_{DS(on)}$ (SMD Version) | 10.8 | mΩ |
| $I_D$                      | -45  | A  |

PG-TO263-3-2    PG-TO262-3-1    PG-TO220-3-1



| Type           | Package      | Marking |
|----------------|--------------|---------|
| IPB45P03P4L-11 | PG-TO263-3-2 | 4P03L11 |
| IPI45P03P4L-11 | PG-TO262-3-1 | 4P03L11 |
| IPP45P03P4L-11 | PG-TO220-3-1 | 4P03L11 |



**Maximum ratings**, at  $T_j=25\text{ °C}$ , unless otherwise specified

| Parameter                           | Symbol         | Conditions                                          | Value        | Unit |
|-------------------------------------|----------------|-----------------------------------------------------|--------------|------|
| Continuous drain current            | $I_D$          | $T_C=25\text{ °C}$ ,<br>$V_{GS}=-10\text{V}^{(1)}$  | -45          | A    |
|                                     |                | $T_C=100\text{ °C}$ ,<br>$V_{GS}=-10\text{V}^{(2)}$ | -42          |      |
| Pulsed drain current <sup>(2)</sup> | $I_{D,pulse}$  | $T_C=25\text{ °C}$                                  | -180         |      |
| Avalanche energy, single pulse      | $E_{AS}$       | $I_D=-22.5\text{A}$                                 | 110          | mJ   |
| Avalanche current, single pulse     | $I_{AS}$       | -                                                   | -45          | A    |
| Gate source voltage                 | $V_{GS}$       | -                                                   | +5/-16       | V    |
| Power dissipation                   | $P_{tot}$      | $T_C=25\text{ °C}$                                  | 58           | W    |
| Operating and storage temperature   | $T_j, T_{stg}$ | -                                                   | -55 ... +175 | °C   |
| IEC climatic category; DIN IEC 68-1 |                | -                                                   | 55/175/56    |      |

| Parameter | Symbol | Conditions | Values |      |      | Unit |
|-----------|--------|------------|--------|------|------|------|
|           |        |            | min.   | typ. | max. |      |

**Thermal characteristics<sup>2)</sup>**

|                                                |            |                                              |   |   |     |     |
|------------------------------------------------|------------|----------------------------------------------|---|---|-----|-----|
| Thermal resistance, junction - case            | $R_{thJC}$ |                                              | - | - | 2.6 | K/W |
| Thermal resistance, junction - ambient, leaded | $R_{thJA}$ |                                              | - | - | 62  |     |
| SMD version, device on PCB                     | $R_{thJA}$ | minimal footprint                            | - | - | 62  |     |
|                                                |            | 6 cm <sup>2</sup> cooling area <sup>3)</sup> | - | - | 40  |     |

**Electrical characteristics, at  $T_j=25^\circ\text{C}$ , unless otherwise specified**
**Static characteristics**

|                                  |               |                                                      |      |       |      |            |
|----------------------------------|---------------|------------------------------------------------------|------|-------|------|------------|
| Drain-source breakdown voltage   | $V_{(BR)DSS}$ | $V_{GS}=0V, I_D=-1mA$                                | -30  | -     | -    | V          |
| Gate threshold voltage           | $V_{GS(th)}$  | $V_{DS}=V_{GS}, I_D=-85\mu A$                        | -1.0 | -1.5  | -2.0 |            |
| Zero gate voltage drain current  | $I_{DSS}$     | $V_{DS}=-24V, V_{GS}=0V, T_j=25^\circ\text{C}$       | -    | -0.02 | -1   | $\mu A$    |
|                                  |               | $V_{DS}=-24V, V_{GS}=0V, T_j=125^\circ\text{C}^{2)}$ | -    | -7    | -70  |            |
| Gate-source leakage current      | $I_{GSS}$     | $V_{GS}=-16V, V_{DS}=0V$                             | -    | -     | -100 | nA         |
| Drain-source on-state resistance | $R_{DS(on)}$  | $V_{GS}=-4.5V, I_D=-25A$                             | -    | 13.1  | 18.7 | m $\Omega$ |
|                                  |               | $V_{GS}=-4.5V, I_D=-25A, \text{SMD version}$         | -    | 12.8  | 18.4 |            |
|                                  |               | $V_{GS}=-10V, I_D=-45A$                              | -    | 9.0   | 11.1 |            |
|                                  |               | $V_{GS}=-10V, I_D=-45A, \text{SMD version}$          | -    | 8.7   | 10.8 |            |

| Parameter | Symbol | Conditions | Values |      |      | Unit |
|-----------|--------|------------|--------|------|------|------|
|           |        |            | min.   | typ. | max. |      |

### Dynamic characteristics<sup>2)</sup>

|                              |              |                                                               |   |      |      |    |
|------------------------------|--------------|---------------------------------------------------------------|---|------|------|----|
| Input capacitance            | $C_{iss}$    | $V_{GS}=0V, V_{DS}=-25V,$<br>$f=1MHz$                         | - | 2900 | 3770 | pF |
| Output capacitance           | $C_{oss}$    |                                                               | - | 835  | 1090 |    |
| Reverse transfer capacitance | $C_{rss}$    |                                                               | - | 21   | 42   |    |
| Turn-on delay time           | $t_{d(on)}$  | $V_{DD}=-15V,$<br>$V_{GS}=-10V, I_D=-45A,$<br>$R_G=3.5\Omega$ | - | 7    | -    | ns |
| Rise time                    | $t_r$        |                                                               | - | 3    | -    |    |
| Turn-off delay time          | $t_{d(off)}$ |                                                               | - | 45   | -    |    |
| Fall time                    | $t_f$        |                                                               | - | 14   | -    |    |

### Gate Charge Characteristics<sup>2)</sup>

|                       |               |                                                         |   |      |    |    |
|-----------------------|---------------|---------------------------------------------------------|---|------|----|----|
| Gate to source charge | $Q_{gs}$      | $V_{DD}=-24V, I_D=-45A,$<br>$V_{GS}=0 \text{ to } -10V$ | - | 11   | 14 | nC |
| Gate to drain charge  | $Q_{gd}$      |                                                         | - | 5    | 10 |    |
| Gate charge total     | $Q_g$         |                                                         | - | 42   | 55 |    |
| Gate plateau voltage  | $V_{plateau}$ |                                                         | - | -3.6 | -  | V  |

### Reverse Diode

|                                                |               |                                                |   |      |      |    |
|------------------------------------------------|---------------|------------------------------------------------|---|------|------|----|
| Diode continuous forward current <sup>2)</sup> | $I_S$         | $T_C=25^\circ C$                               | - | -    | -45  | A  |
| Diode pulse current <sup>2)</sup>              | $I_{S,pulse}$ |                                                | - | -    | -180 |    |
| Diode forward voltage                          | $V_{SD}$      | $V_{GS}=0V, I_F=-45A,$<br>$T_j=25^\circ C$     | - | -1.0 | -1.3 | V  |
| Reverse recovery time <sup>2)</sup>            | $t_{rr}$      | $V_R=-15V, I_F=-45A,$<br>$di_F/dt=-100A/\mu s$ | - | 35   | -    | ns |
| Reverse recovery charge <sup>2)</sup>          | $Q_{rr}$      |                                                | - | 26   | -    | nC |

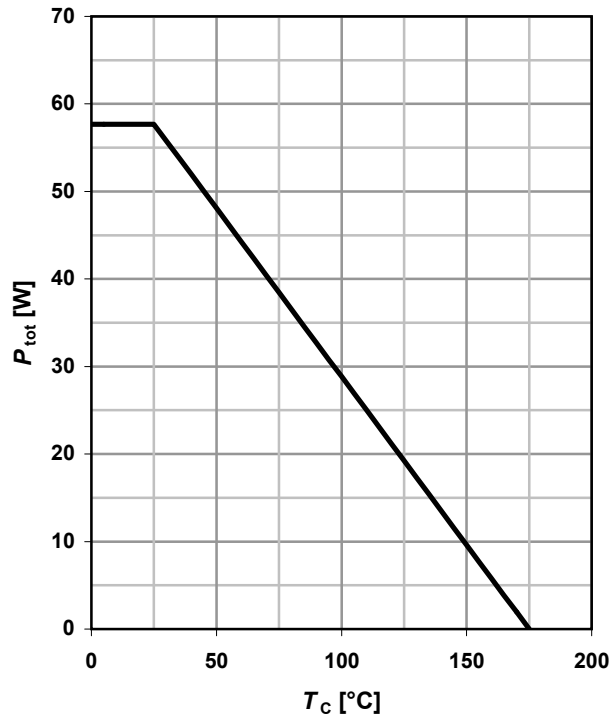
<sup>1)</sup> Current is limited by bondwire; with an  $R_{thJC} = 2.6K/W$  the chip is able to carry -A at 25°C.

<sup>2)</sup> Defined by design. Not subject to production test.

<sup>3)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

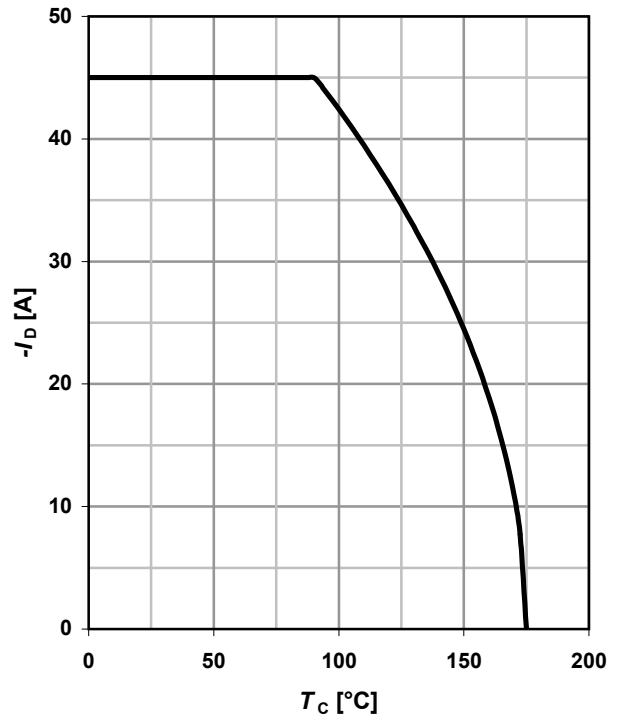
### 1 Power dissipation

$$P_{\text{tot}} = f(T_C); V_{\text{GS}} \leq -6\text{V}$$



### 2 Drain current

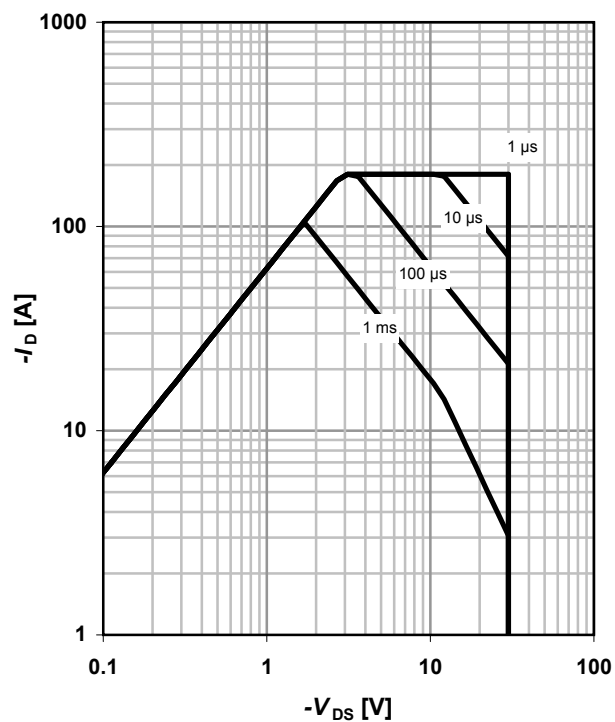
$$I_D = f(T_C); V_{\text{GS}} \leq -6\text{V}; \text{SMD}$$



### 3 Safe operating area

$$I_D = f(V_{\text{DS}}); T_C = 25^\circ\text{C}; D = 0; \text{SMD}$$

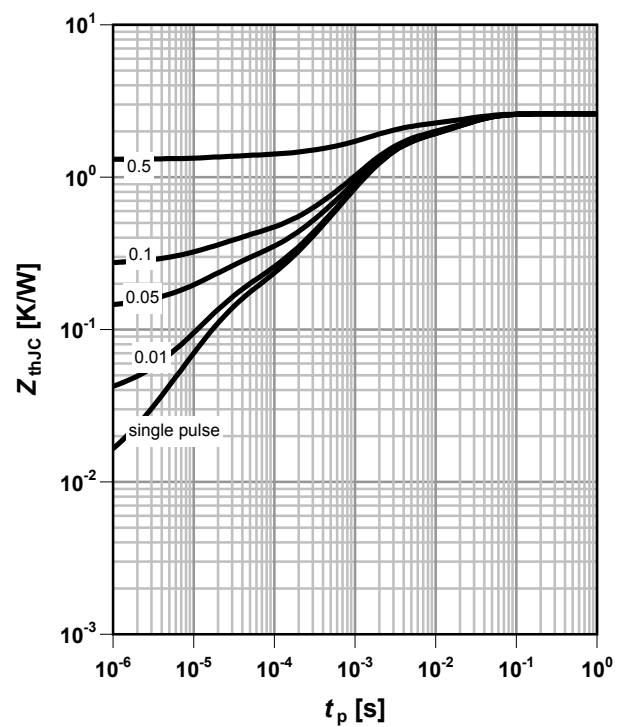
parameter:  $t_p$



### 4 Max. transient thermal impedance

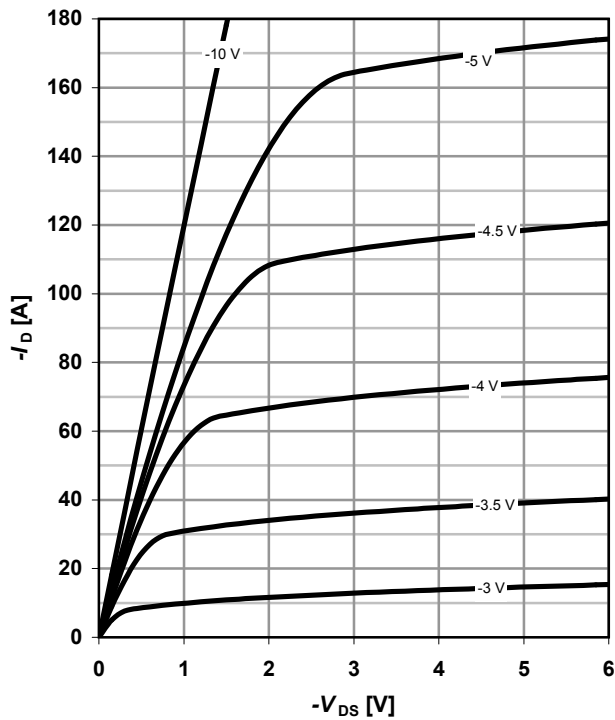
$$Z_{\text{thJC}} = f(t_p)$$

parameter:  $D = t_p/T$



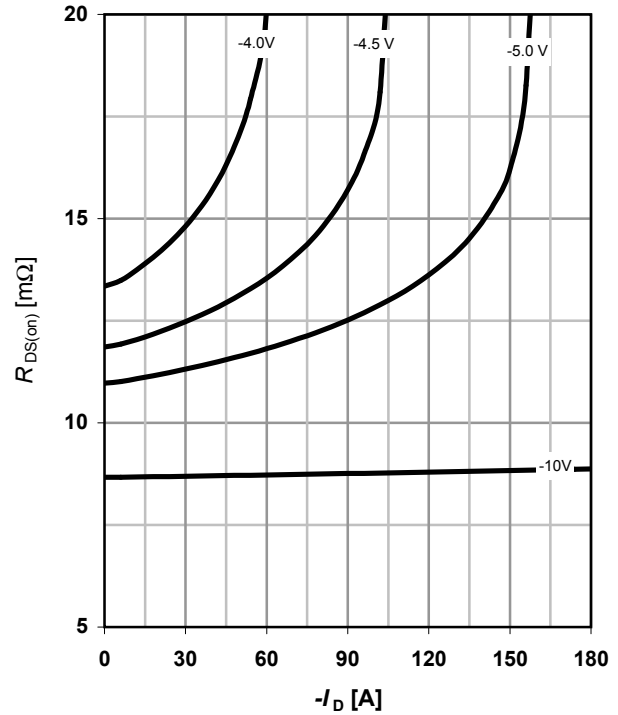
## 5 Typ. output characteristics

 $I_D = f(V_{DS}); T_j = 25^\circ\text{C}; \text{SMD}$ 

parameter:  $V_{GS}$ 


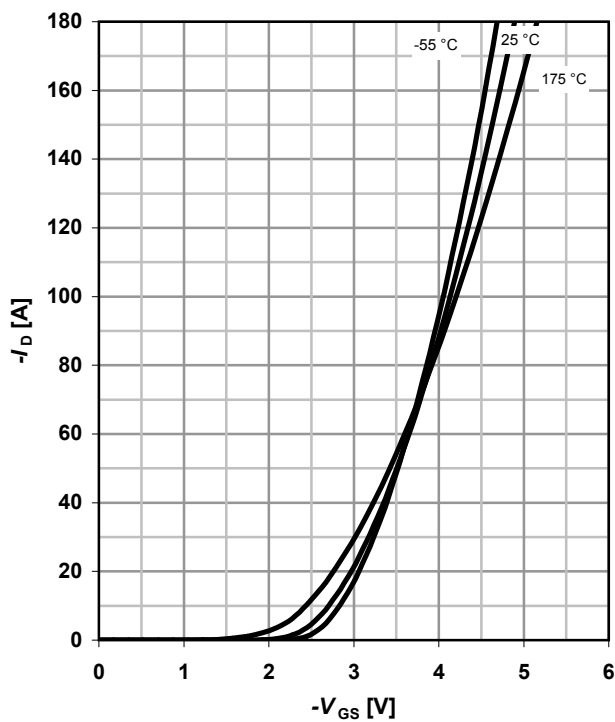
## 6 Typ. drain-source on-state resistance

 $R_{DS(on)} = f(I_D); T_j = 25^\circ\text{C}; \text{SMD}$ 

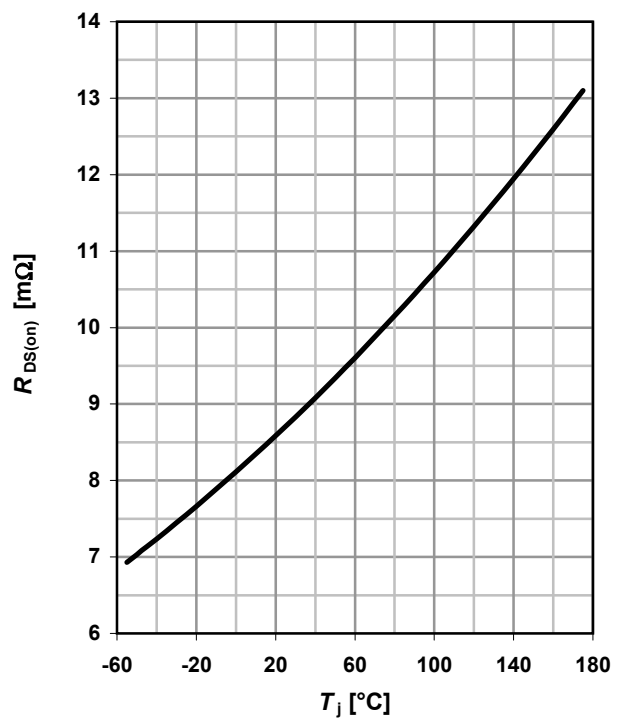
parameter:  $V_{GS}$ 


## 7 Typ. transfer characteristics

 $I_D = f(V_{GS}); V_{DS} = -6V$ 

parameter:  $T_j$ 


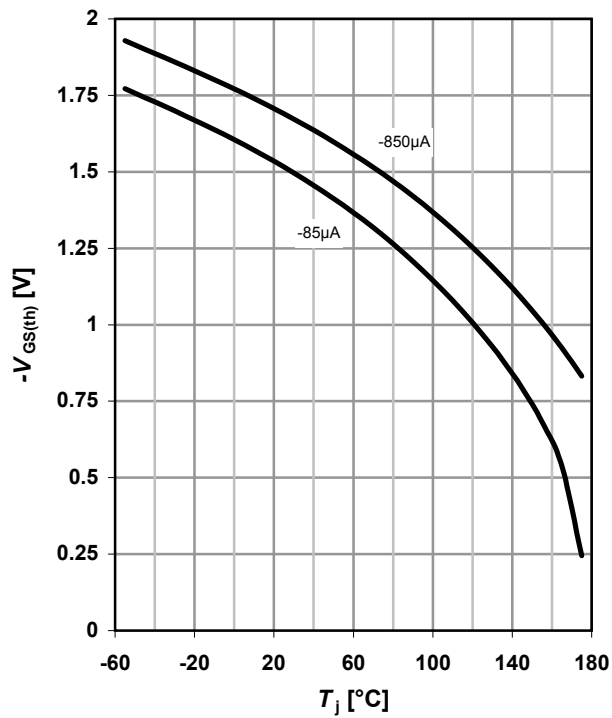
## 8 Typ. drain-source on-state resistance

 $R_{DS(on)} = f(T_j); I_D = -45A; V_{GS} = -10V; \text{SMD}$ 


## 9 Typ. gate threshold voltage

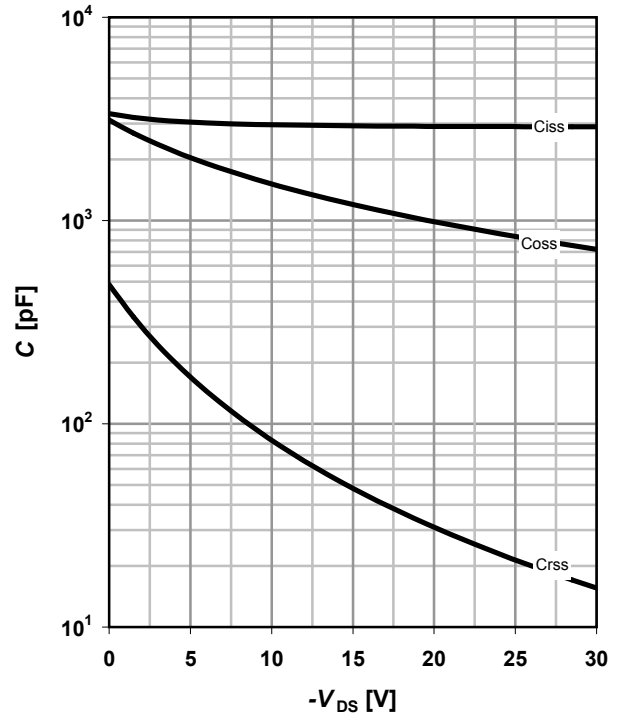
$$V_{GS(th)} = f(T_j); V_{GS} = V_{DS}$$

parameter:  $I_D$



## 10 Typ. capacitances

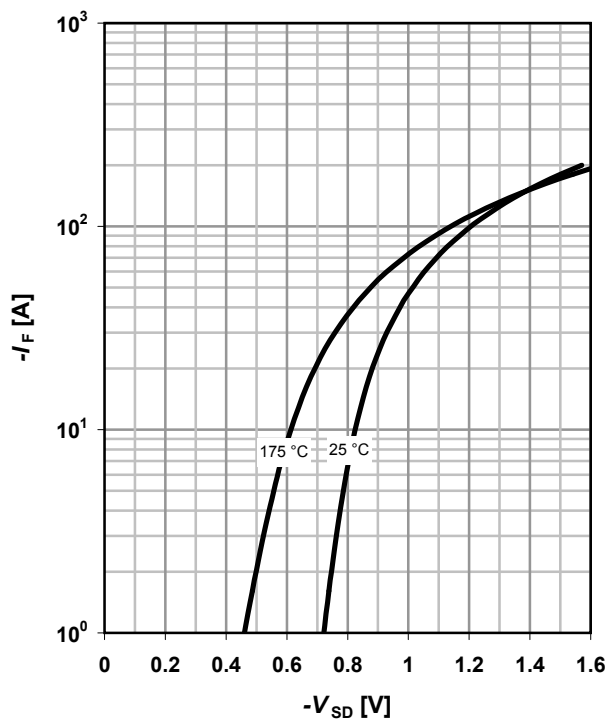
$$C = f(V_{DS}); V_{GS} = 0 V; f = 1 MHz$$



## 11 Typical forward diode characteristics

$$I_F = f(V_{SD})$$

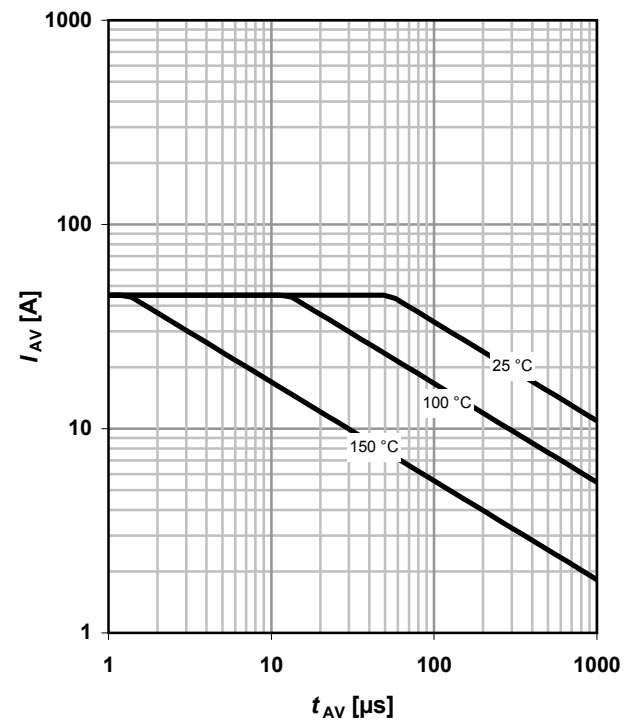
parameter:  $T_j$



## 12 Avalanche characteristics

$$I_{AS} = f(t_{AV})$$

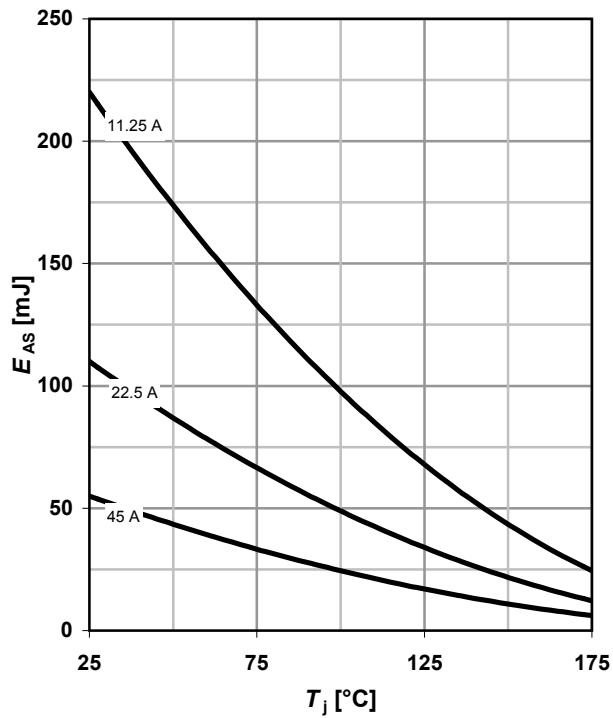
parameter:  $T_{j(start)}$



### 13 Avalanche energy

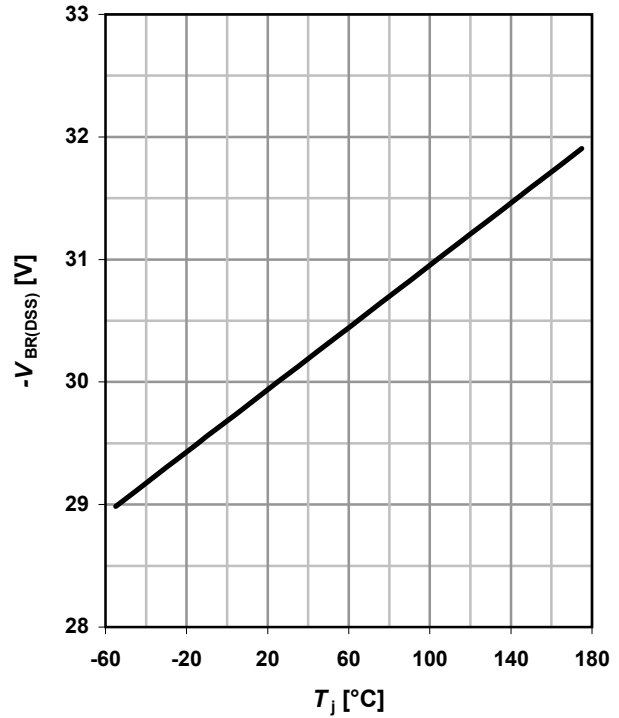
$$E_{AS} = f(T_j)$$

parameter:  $I_D$



### 14 Drain-source breakdown voltage

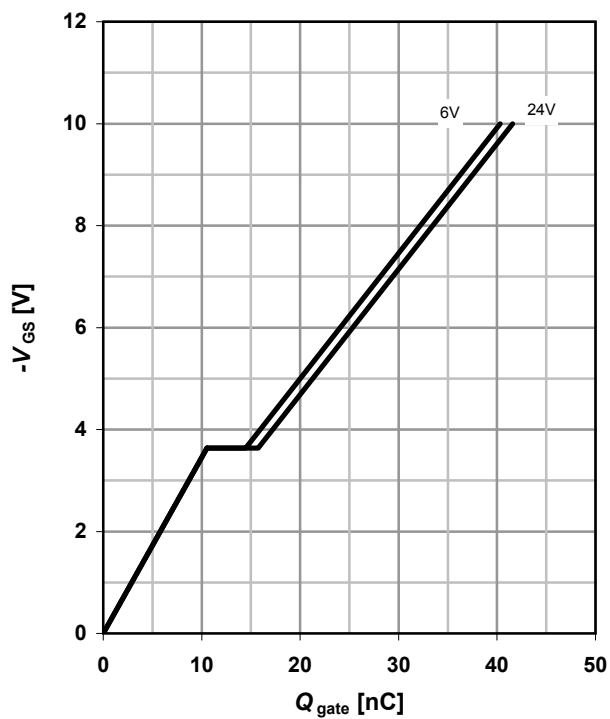
$$V_{BR(DSS)} = f(T_j); I_D = 1\text{mA}$$



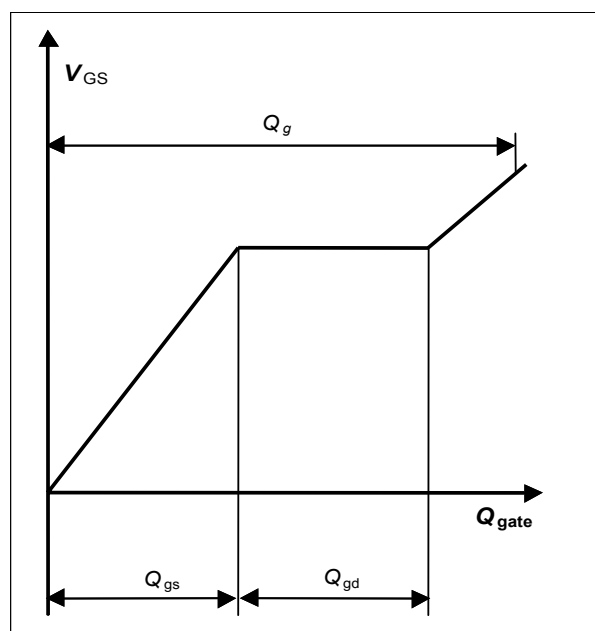
### 15 Typ. gate charge

$$V_{GS} = f(Q_{gate}); I_D = -45\text{A pulsed}$$

parameter:  $V_{DD}$



### 16 Gate charge waveforms



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## Revision History

| Version | Date | Changes |
|---------|------|---------|
|         |      |         |
|         |      |         |
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